

02-18-1999

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To the Honorable Commissioner of Patent

inal documents or copy thereof.

1. Name of conveying party(ies):

YUN-HUNG SHEN

MID
2-5-99

2. Name and address of receiving party(ies):

Name: **Taiwan Semiconductor Manufacturing Company**

Internal Address:

Street Address:

121 Park Ave. 3
Science-Based Industrial Park
City: Hsin-Chu Zip:
Country: Taiwan, R.O.C.JC530 U.S. PTO
09/245563
02/05/99Additional name(s) or conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance



Assignment



Merger



Security Agreement



Change of Name



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Execution Date: **1/13/99**Additional name(s) & address(es) attached? Yes ☐ No ☒

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: **1/13/99**

A. Patent Application No(s)

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **GEORGE O. SAILE**

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Street Address: **20 MCINTOSH DRIVE**City: **POUGHKEEPSIE** State: **NY** ZIP: **12603**6. Total no. of applications and patents involved: **1**7. Total fee (37 CFR 3.41): **\$ 40.00**

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ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

YUN - HUNG SHEN
Type or print name of ASSIGNOR

4F, No. 44~4 Shie-Chun Rd.
Address Shi-Lin District
Taipei, Taiwan

Republic of China
Nationality

ASSIGNEE:

Taiwan Semiconductor Manufacturing Co. Ltd.
121 Park Ave. 3
Science-Based Industrial Park
Hsin-Chu, Taiwan, R.O.C.
Taiwan, R.O.C.
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- ☒ the entire right, title and interest
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in and to any and all improvements which are disclosed in the invention entitled:

Method For Forming Electrical Contacts Through Multi-Level Dielectric Layers By High Density Plasma Etching

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith
(b) ☐ U.S. patent application executed on _____
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IN WITNESS WHEREOF, I / We have signed this

1/13/1999 (Date of signing)

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Jun - Hung Shen
Signature of ASSIGNOR(S)

If ASSIGNOR is a legal entity complete the following information

Type or print the name of the above person authorized to sign on
behalf of ASSIGNOR

Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

____ Notarization of Legalization Page Added.